20-Channel, Serial-Input, Vacuum-Fluorescent Display Driver for Anode/Grid

Features

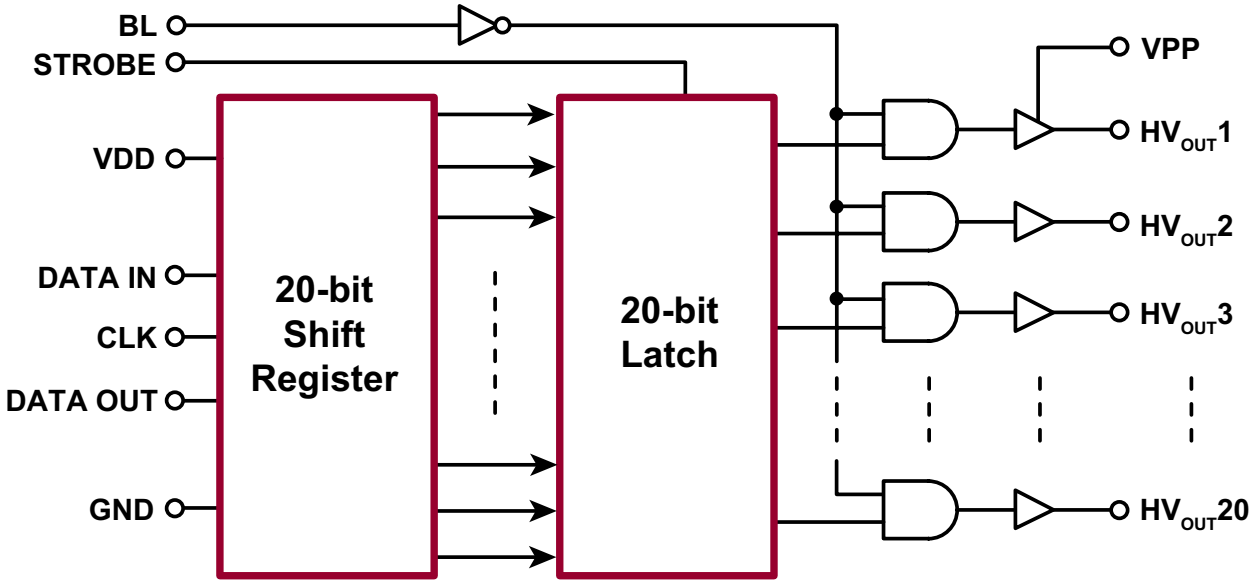
- HVCMOS® technology for high performance
- Operating voltage up to 80V
- High speed source driver
- 5.0V CMOS logic circuitry
- Up to 5.0MHz data input rate
- Excellent noise immunity
- Flexible high voltage supplies

General Description

The Supertex HV5812 is a 20-channel, serial input, vacuum-fluorescent display driver. It combines a 20-bit CMOS shift register, data latches, and control circuitry with high voltage MOSFET outputs. The HV5812 is primarily designed for vacuum-fluorescent displays.

The CMOS shift register and latches allow direct interfacing with microprocessor based systems. Data input rates are typically over 5.0MHz with 5.0V logic supply. Especially useful for interdigit blanking, the BLANKING input disables the output source drives and turns on the sink drivers. Use with TTL may require external pull-up resistors to ensure an input logic high.

Functional Block Diagram



Ordering Information

Part Number	Package	Packing
HV5812P-G	28-Lead PDIP	13/Tube
HV5812PJ-G	28-Lead PLCC	38/Tube
HV5812PJ-G M904	28-Lead PLCC	500/Reel
HV5812WG-G	28-LeadSOW	1000/Reel

-G denotes a lead (Pb)-free / RoHS compliant package

Absolute Maximum Ratings

Parameter	Value
Supply voltage, V_{DD}	-0.5V to +7.5V
Supply voltage, V_{PP}	-0.5V to +90V
Logic input levels	-0.3V to V_{DD} +0.3V
Maximum junction temperature	125°C
Storage temperature range	-55°C to +150°C
Power dissipation: 28-Lead PDIP 28-Lead PLCC 28-Lead SOW	 2000mW 1900mW 1700mW

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to GND.

Recommended Operating Conditions

Sym	Parameter	Min	Max	Units
V_{DD}	Supply voltage	4.5	5.5	V
V_{PP}	Supply voltage	20	80	V
T_j	Operating junction temperature	-40	+125	°C

Power-up sequence should be the following:

1. Connect ground.
2. Apply V_{DD}.
3. Set all inputs (Data, CLK, etc.) to a known state.
4. Apply V_{PP}.

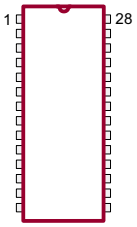
The V_{PP} should not drop below V_{DD} during operation.

Power-down sequence should be the reverse of the above.

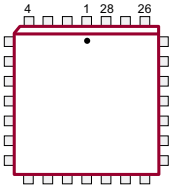
Typical Thermal Resistance

Package	θ_{ja}
28-Lead PDIP	43°C/W
28-Lead PLCC	48°C/W
28-Lead SOW	55°C/W

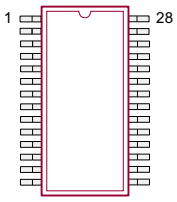
Pin Configuration



28-Lead PDIP



28-Lead PLCC

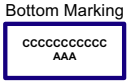


28-Lead SOW

Product Marking

Top Marking

Bottom Marking



YY = Year Sealed
WW = Week Sealed
L = Lot Number
C = Country of Origin*
A = Assembler ID*
———— = "Green" Packaging

**May be part of top marking*

Package may or may not include the following marks: Si or

28-Lead PDIP

Top Marking

Bottom Marking

YY = Year Sealed
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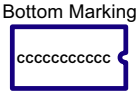
28-Lead PLCC

Top Marking

Bottom Marking



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———— = "Green" Packaging

**May be part of top marking*

Package may or may not include the following marks: Si or

28-Lead SOW

Electrical Characteristics

DC Characteristics *(over recommended operating conditions, T_A = 25°C, unless otherwise noted)*

Sym	Parameter		Min	Typ	Max	Units	Conditions
I_{DSS}	Output leakage current		-	-5.0	-15	µA	V_{OUT} = 0V, T_A = +70°C
V_{OH}	High-level output	HV_{OUT}	78	78.5	-	V	I_{OUT} = -25mA, V_{PP} = 80V, T_j = +25°C
			77	78	-		I_{OUT} = -25mA, V_{PP} = 80V, T_j = +125°C
		DATA OUT	4.5	4.7	-	V	I_{OUT} = -200µA, V_{DD} = 5.0V
V_{OL}	Low-level output	HV_{OUT}	-	1.5	3.0	V	I_{OUT} = 1.0mA, T_j = +25°C, V_{DD} = 5.0V
			-	2.3	4.0		I_{OUT} = 1.0mA, T_j = +125°C, V_{DD} = 5.0V
		DATA OUT	-	200	250	V	I_{OUT} = +200µA, V_{DD} = 5.0V
I_{SINK}	Output pull-down current		2.0	3.5	-	mA	V_{OUT} = 5.0V to V_{PP}, V_{DD} = 5.0V
V_{IH}	High level logic input voltage		3.5	-	5.3	V	V_{DD} = 5.0V
V_{IL}	Low level logic input voltage		-0.3	-	0.8	V	---
I_{IH}	High level logic input current		-	0.05	0.5	µA	V_{IN} = V_{DD}, V_{DD} = 5.0V
I_{IL}	Low level logic input current		-	-0.05	-0.5	µA	V_{IN} = 0.8V, V_{DD} = 5.0V
I_{DDQ}	Quiescent V_{DD} supply current		-	100	300	µA	All outputs high, V_{DD} = 5.0V
			-	100	300		All outputs low, V_{DD} = 5.0V
I_{PPQ}	Quiescent V_{PP} supply current		-	10	100	µA	All outputs high, no load
			-	10	100		All outputs low, no load

AC Characteristics *(over recommended operating conditions, T_A = 25°C, unless otherwise noted)*

t_{PHL}	Blanking to output delay	-	2000	-	ns	C_L = 30pF, 50% to 50%, V_{DD} = 5.0V
t_{PLH}		-	1000	-		
t_f	Output fall time	-	1450	-	ns	C_L = 30pF, 90% to 10%, V_{DD} = 5.0V
t_r	Output rise time	-	650	-	ns	C_L = 30pF, 10% to 90%, V_{DD} = 5.0V
t_{su}	Data set-up time	75	-	-	ns	See timing diagram
t_h	Data hold time	75	-	-	ns	See timing diagram
t_{pwd}	Minimum data pulse width	150	-	-	ns	See timing diagram
t_{pwclk}	Minimum clock pulse width	150	-	-	ns	See timing diagram
t_{cks}	Minimum time between clock activation and strobe	300	-	-	ns	See timing diagram
t_{pws}	Minimum strobe pulse width	100		-	ns	See timing diagram
t_{sto}	Typical time between strobe activation and output transition	-	500	-	ns	See timing diagram
f_{CLK}	Maximum clock frequency	-	8.0	-	MHz	T_j = +25°C, V_{DD} = 5.0V
		-	5.0	-		T_j = +125°C, V_{DD} = 5.0V

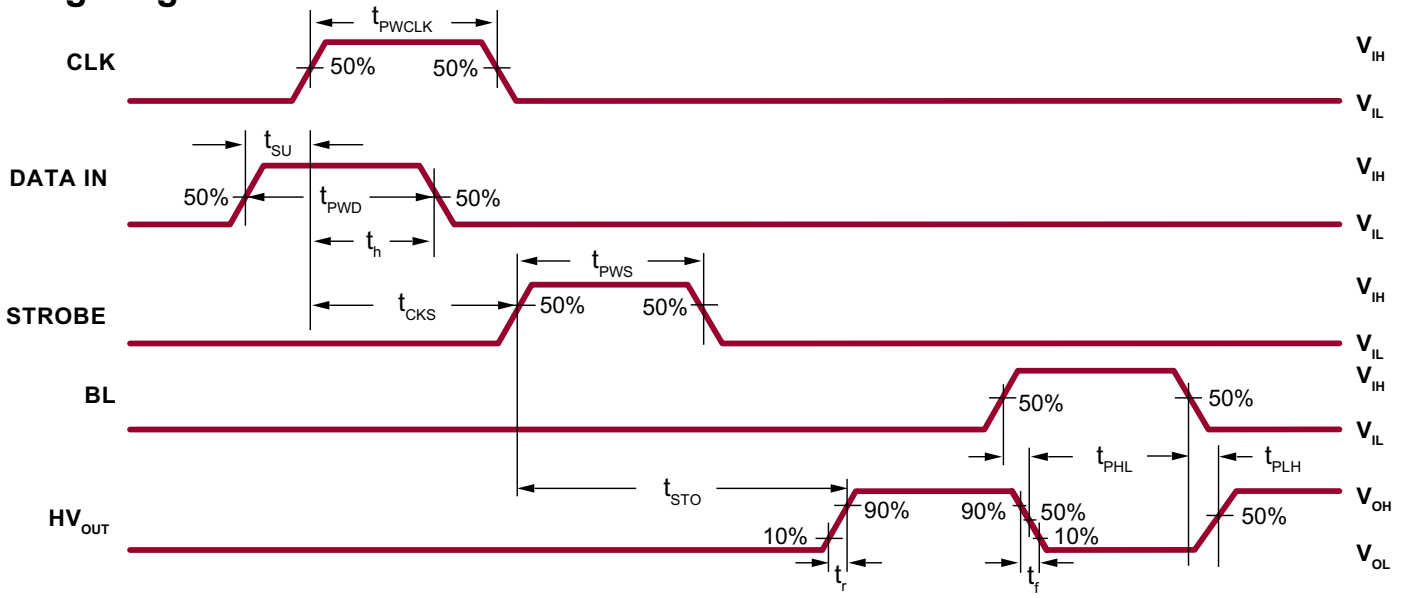
Function Table

Serial Data Input	Clock Input	Shift Register Contents				Serial Data Output	Strobe Input	Latch Content				Blanking	Output Content				
		I_1	I_2	$I_3 \dots I_{N-1}$	I_N			I_1	I_2	$I_3 \dots I_{N-1}$	I_N		I_1	I_2	$I_3 \dots I_{N-1}$	I_N	
H	L to H	H	R_1	$R_2 \dots R_{N-2}$	R_{N-1}	R_{N-1}	-	-	-	-	-	-	-	-	-	-	-
L	L to H	L	R_1	$R_2 \dots R_{N-2}$	R_{N-1}	R_{N-1}	-	-	-	-	-	-	-	-	-	-	-
X	H to L	R_1	R_2	$R_3 \dots R_{N-1}$	R_N	R_N	-	-	-	-	-	-	-	-	-	-	-
-	-	X	X	X ... X	X	X	L	R_1	R_2	$R_3 \dots R_{N-1}$	R_N	-	-	-	-	-	-
-	-	P_1	P_2	$P_3 \dots P_{N-1}$	P_N	P_N	H	P_1	P_2	$P_3 \dots P_{N-1}$	P_N	L	P_1	P_2	$P_3 \dots P_{N-1}$	P_N	
-	-	-	-	-	-	-	-	X	X	X ... X	X	H	L	L	L ... L	L	

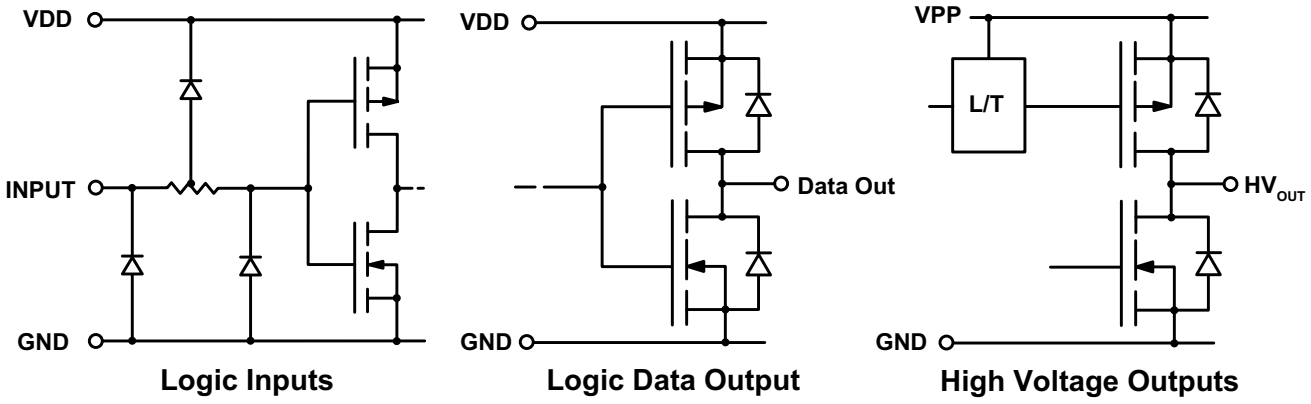
Note:

L = Low logic level
H = High logic level
X = Irrelevant
P = Present state
R = Previous state

Timing Diagram



Input and Output Equivalent Circuits



28-Lead PDIP Pin Description

Pin #	Function
1	VPP
2	Data Out
3	$HV_{OUT}20$
4	$HV_{OUT}19$
5	$HV_{OUT}18$
6	$HV_{OUT}17$
7	$HV_{OUT}16$
8	$HV_{OUT}15$
9	$HV_{OUT}14$
10	$HV_{OUT}13$

Pin #	Function
11	$HV_{OUT}12$
12	$HV_{OUT}11$
13	BLANKING
14	GND
15	CLOCK
16	STROBE
17	$HV_{OUT}10$
18	$HV_{OUT}9$
19	$HV_{OUT}8$
20	$HV_{OUT}7$

Pin #	Function
21	$HV_{OUT}6$
22	$HV_{OUT}5$
23	$HV_{OUT}4$
24	$HV_{OUT}3$
25	$HV_{OUT}2$
26	$HV_{OUT}1$
27	Data In
28	VDD

28-Lead PLCC Pin Description

Pin #	Function
1	VPP
2	Data Out
3	$HV_{OUT}20$
4	$HV_{OUT}19$
5	$HV_{OUT}18$
6	$HV_{OUT}17$
7	$HV_{OUT}16$
8	$HV_{OUT}15$
9	$HV_{OUT}14$
10	$HV_{OUT}13$

Pin #	Function
11	$HV_{OUT}12$
12	$HV_{OUT}11$
13	BLANKING
14	GND
15	CLOCK
16	STROBE
17	$HV_{OUT}10$
18	$HV_{OUT}9$
19	$HV_{OUT}8$
20	$HV_{OUT}7$

Pin #	Function
21	$HV_{OUT}6$
22	$HV_{OUT}5$
23	$HV_{OUT}4$
24	$HV_{OUT}3$
25	$HV_{OUT}2$
26	$HV_{OUT}1$
27	Data In
28	VDD

28-Lead SOW Pin Description

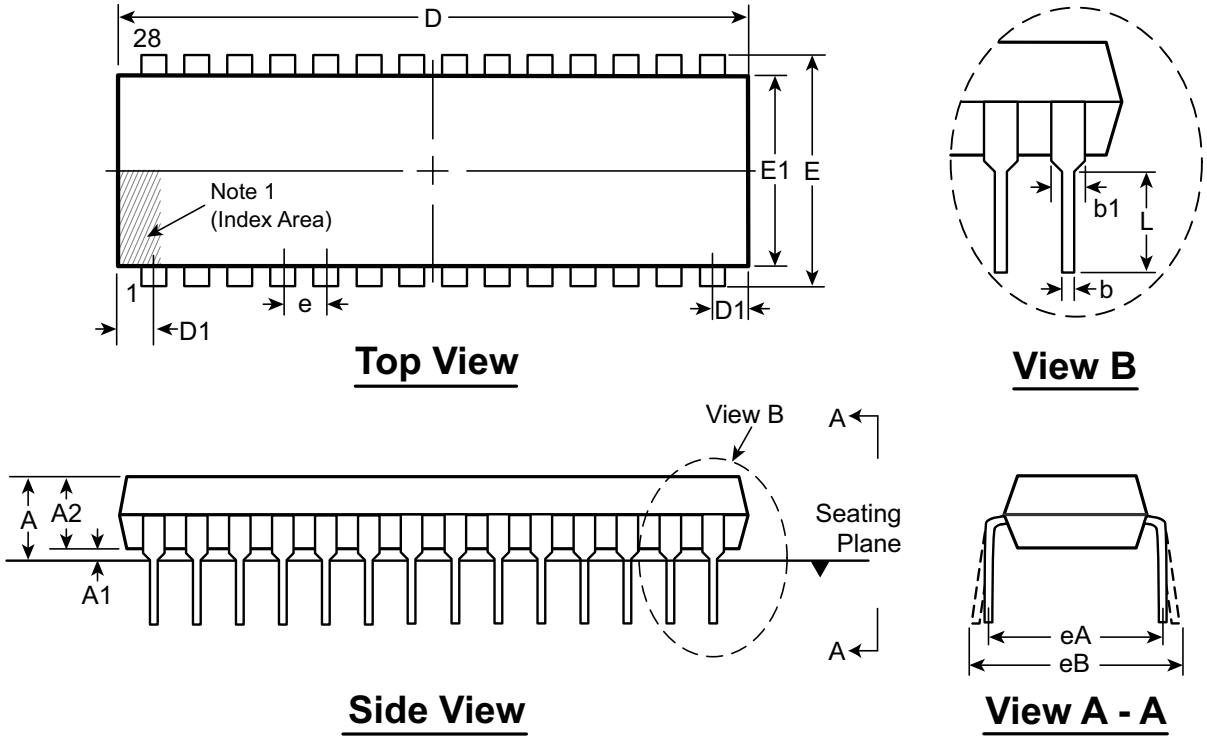
Pin #	Function
1	VPP
2	Data Out
3	$HV_{OUT}20$
4	$HV_{OUT}19$
5	$HV_{OUT}18$
6	$HV_{OUT}17$
7	$HV_{OUT}16$
8	$HV_{OUT}15$
9	$HV_{OUT}14$
10	$HV_{OUT}13$

Pin #	Function
11	$HV_{OUT}12$
12	$HV_{OUT}11$
13	BLANKING
14	GND
15	CLOCK
16	STROBE
17	$HV_{OUT}10$
18	$HV_{OUT}9$
19	$HV_{OUT}8$
20	$HV_{OUT}7$

Pin #	Function
21	$HV_{OUT}6$
22	$HV_{OUT}5$
23	$HV_{OUT}4$
24	$HV_{OUT}3$
25	$HV_{OUT}2$
26	$HV_{OUT}1$
27	Data In
28	VDD

28-Lead PDIP (.600in Row Spacing) Package Outline (P)

1.565x.580in body, .250in height (max), .100in pitch



Note:

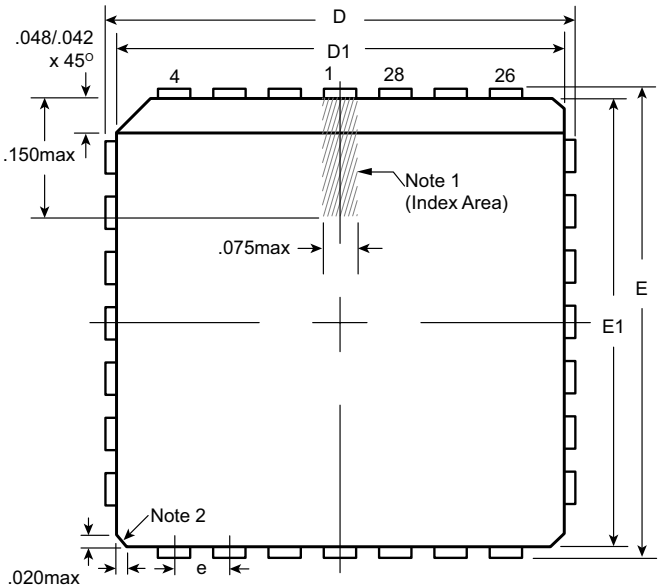
1. *A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.*

Symbol		A	A1	A2	b	b1	D	D1	E	E1	e	eA	eB	L
Dimension (inches)	MIN	.140*	.015	.125	.014	.030	1.380	.065†	.590†	.485	.100 BSC	.600 BSC	.600*	.115
	NOM	-	-	-	-	-	-	-	-	-			-	-
	MAX	.250	.055*	.195	.023†	.070	1.565	.085*	.625	.580			.700	.200

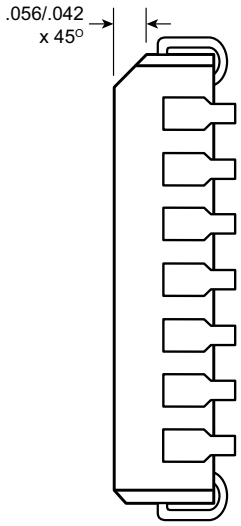
JEDEC Registration MS-011, Variation AB, Issue B, June, 1988.
** This dimension is not specified in the JEDEC drawing.*
† This dimension differs from the JEDEC drawing.
Drawings not to scale.
Supertex Doc. #: *DSPD-28DIPP, Version B041009.*

28-Lead PLCC Package Outline (PJ)

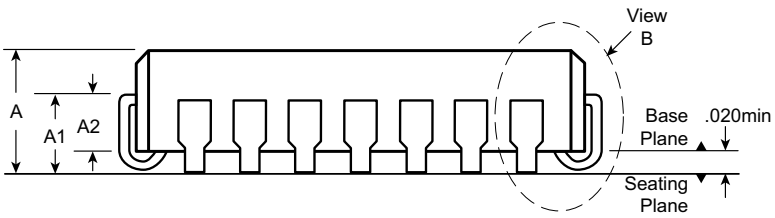
.453x.453in. body, .180in. height (max), .050in. pitch



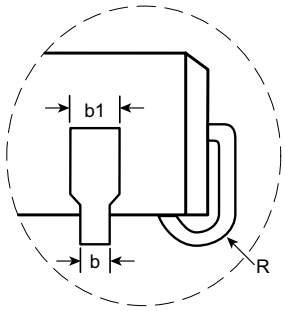
Top View



Vertical Side View



Horizontal Side View



View B

Notes:

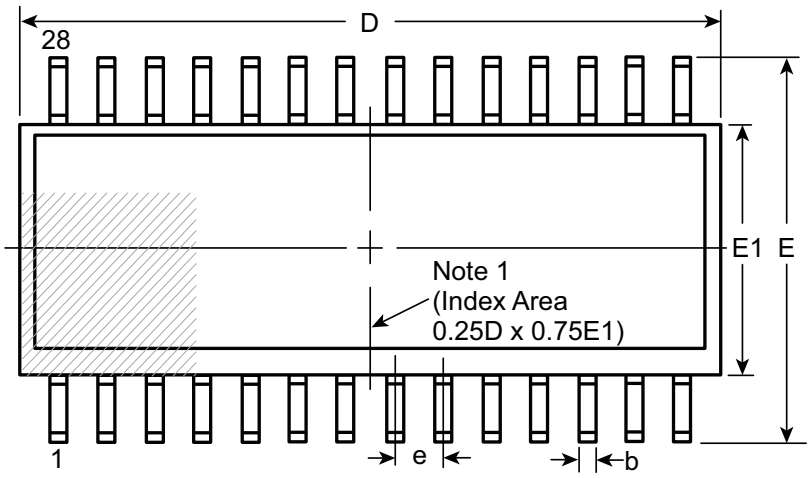
1. *A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.*
2. *Actual shape of this feature may vary.*

Symbol		A	A1	A2	b	b1	D	D1	E	E1	e	R
Dimension (inches)	MIN	.165	.090	.062	.013	.026	.485	.450	.485	.450	.050 BSC	.025
	NOM	.172	.105	-	-	-	.490	.453	.490	.453		.035
	MAX	.180	.120	.083	.021	.032	.495	.456	.495	.456		.045

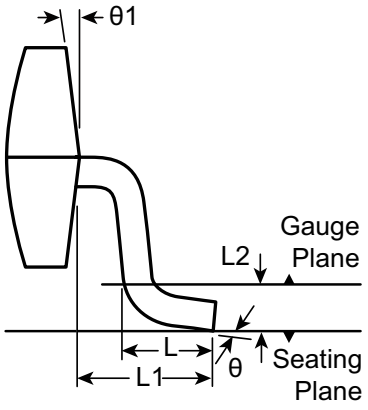
JEDEC Registration MS-018, Variation AB, Issue A, June, 1993.
Drawings not to scale.
Supertex Doc. #: *DSPD-28PLCCPJ, Version B031111.*

28-Lead SOW (Wide Body) Package Outline (WG)

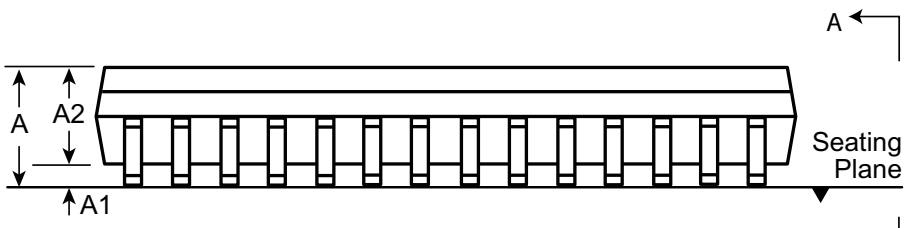
17.90x7.50mm body, 2.65mm height (max), 1.27mm pitch



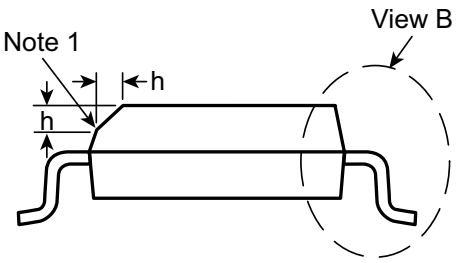
Top View



View B



Side View



View A-A

Note:

1. *A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.*

Symbol		A	A1	A2	b	D	E	E1	e	h	L	L1	L2	θ	θ1
Dimension (mm)	MIN	2.15*	0.10	2.05	0.31	17.70*	9.97*	7.40*	1.27 BSC	0.25	0.40	1.40 REF	0.25 BSC	0°	5°
	NOM	-	-	-	-	17.90	10.30	7.50		-	-			-	-
	MAX	2.65	0.30	2.55*	0.51	18.10*	10.63*	7.60*		0.75	1.27			8°	15°

JEDEC Registration MS-013, Variation AE, Issue E, Sep. 2005.
** This dimension is not specified in the JEDEC drawing.*
Drawings are not to scale.
***Supertex Doc. #:** DSPD-28SOWWG, Version D041309.*

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to: http://www.supertex.com/packaging.html.)

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